INTEGRATED CIRCUITS

DATA SHEET

74LVC16241A16-bit buffer/line driver (3-State)

Product specification Supersedes data of 1995 Dec 26 IC24 Data Handbook





16-bit buffer/line driver (3-State)

74LVC16241A

FEATURES

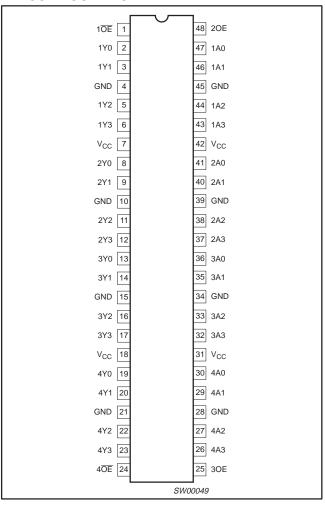
- 5 volt tolerant inputs/outputs for interfacing with 5V logic
- Wide supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A
- CMOS low power consumption
- MULTIBYTETM flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels

DESCRIPTION

The 74LVC16241A is a high-performance, low-power, low-voltage, Si-gate CMOS device, superior to most advanced CMOS compatible TTL families. Inputs can be driven from either 3.3V or 5V devices. In 3-State operation, outputs can handle 5V. These features allow the use of these devices in a mixed 3.3V/5V environment.

The 74LVC16241A is a 16-bit buffer/line driver with 3-State outputs. The 3-State outputs are controlled by the output enable inputs noe and noe. Schmitt-trigger action at all inputs makes the circuit highly tolerant for slower input rise and fall times. The device can be used as four 4-bit buffers, two 8-bit buffers or one 16-bit buffer.

PIN CONFIGURATION



QUICK REFERENCE DATA

GND = 0 V; T_{amb} = 25 °C; $t_r = t_f \le 2.5 \text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay nAn to nYn	$C_L = 50pF$ $V_{CC} = 3.3V$	2.9	ns
C _I	Input capacitance		5.0	pF
C _{PD}	Power dissipation capacitance per buffer	$V_I = GND \text{ to } V_{CC}^1$	25	pF

NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; C_L = output load capacity in pF;

 f_0 = output frequency in MHz; V_{CC} = supply voltage in V;

 Σ (C_L x V_{CC}² x f_o) = sum of outputs.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
48-Pin Plastic SSOP Type III	–40°C to +85°C	74LVC16241A DL	VC16241A DL	SOT370-1
48-Pin Plastic TSSOP Type II	-40°C to +85°C	74LVC16241A DGG	VC16241A DGG	SOT362-1

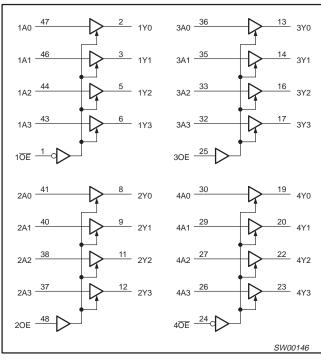
16-bit buffer/line driver (3-State)

74LVC16241A

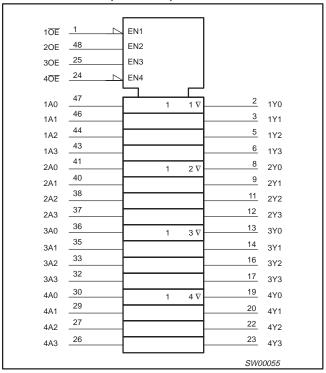
PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	1 O E	Output enable input (active LOW)
2, 3, 5, 6	1Y0 to 1Y3	Data outputs
4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V _{CC}	Positive supply voltage
8, 9, 11, 12	2Y0 to 2Y3	Data outputs
13, 14, 16, 17	3Y0 to 3Y3	Data outputs
19, 20, 22, 23	4Y0 to 4Y3	Data outputs
24	4 OE	Output enable input (active LOW)
25	30E	Output enable input (active LOW)
30, 29, 27, 26	4A0 to 4A3	Data inputs
36, 35, 33, 32	3A0 to 3A3	Data inputs
41, 40, 38, 37	2A0 to 2A3	Data inputs
47, 46, 44, 43	1A0 to 1A3	Data inputs
48	20E	Output enable input (active LOW)

LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLES

INP	OUTPUT				
nOE	nŌE 1An, 4An				
L	Н	Н			
L	L	L			
Н	X	Z			

INP	INPUTS					
nOE	2An, 3An	2Yn, 3Yn				
Н	Н	Н				
Н	L	L				
L	Х	Z				

H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high impedance OFF-state

16-bit buffer/line driver (3-State)

74LVC16241A

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIM	UNIT		
STWIBUL	PARAMETER	CONDITIONS	MIN.	MAX.	T ONL	
V _{CC}	DC supply voltage (for max. speed performance)		2.7	3.6	V	
V _{CC}	DC supply voltage (for low-voltage applications)		1.2	3.6	V	
VI	DC Input voltage range		0	5.5	V	
Vo	DC output voltage range; output HIGH or LOW state		0	V _{CC}	V	
Vo	DC output voltage range; output 3-State		0	5.5	V	
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics for individual device	-40	+85	°C	
t _r , t _f	Input rise and fall times	$V_{CC} = 1.2 \text{ to } 2.7V$ $V_{CC} = 2.7 \text{ to } 3.6V$	0	20 10	ns/V	

ABSOLUTE MAXIMUM RATINGS¹

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	DADAMETED	CONDITIONS	LI	UNIT	
	PARAMETER	CONDITIONS	MIN	MAX	UNII
V _{CC}	DC supply voltage		-0.5	+6.5	V
I _{IK}	DC input diode current	V _I < 0	-	-50	mA
V _I	DC input voltage	Note 2	-0.5	+6.5	V
I _{OK}	DC output diode current	$V_O > V_{CC}$ or $V_O < 0$	-	±50	mA
Vo	DC output voltage; output HIGH or LOW state	Note 2	-0.5	V _{CC} + 0.5	V
Vo	DC output voltage; output 3-State	Note 2	-0.5	6.5	V
ΙO	DC output source or sink current	$V_O = 0$ to V_{CC}	-	±50	mA
I _{GND} , I _{CC}	DC V _{CC} or GND current		-	±100	mA
T _{stg}	Storage temperature range	Ī	-65	+150	°C
	Power dissipation per package				
P _{tot}	– SO package	Above +70°C derate linearly 8mW/K		500	mW
	 SSOP and TSSOP package 	Above +60°C derate linearly 5.5mW/K		500	

NOTES:

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output clamp current ratings are observed.

16-bit buffer/line driver (3-State)

74LVC16241A

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V)

			L					
SYMBOL	PARAMETER	TEST CONDITIONS	Temp = -	Temp = -40°C to +85°C				
			MIN	TYP ¹	MAX			
.,	LUCI Laval lamit valta sa	V _{CC} = 1.2V	V _{CC}			V		
V _{IH}	HIGH level Input voltage	V _{CC} = 2.7 to 3.6V	2.0			\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
V	LOW level length voltage	V _{CC} = 1.2V			GND	V		
V _{IL}	LOW level Input voltage	V _{CC} = 2.7 to 3.6V			0.8	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -12mA$	V _{CC} -0.5					
	HIGH level output voltage	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -100 \mu A$	V _{CC} -0.2	V _{CC}		-		
V _{OH}		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -18$ mA	V _{CC} -0.6					
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -24$ mA	V _{CC} -0.8					
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 12mA$			0.40			
V _{OL}	LOW level output voltage	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		GND	0.20	V		
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 24$ mA			0.55			
t _l	Input leakage current	V _{CC} = 3.6V; V _I = 5.5V or GND		±0.1	±5	μΑ		
l _{OZ}	3-State output OFF-state current	$V_{CC} = 3.6V$; $V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5V$ or GND		0.1	±5	μΑ		
I _{off}	Power off leakage supply	$V_{CC} = 0.0V; V_{I} \text{ or } V_{O} = 5.5V$		0.1	±10	μΑ		
I _{CC}	Quiescent supply current	$V_{CC} = 3.6V$; $V_I = V_{CC}$ or GND; $I_O = 0$		0.1	20	μΑ		
Δl _{CC}	Additional quiescent supply current per input pin	$V_{CC} = 2.7 \text{V to } 3.6 \text{V}; V_{I} = V_{CC} - 0.6 \text{V}; I_{O} = 0$		5	500	μА		

NOTE:

AC CHARACTERISTICS

GND = 0V; $t_R = t_F = 2.5 \text{ns}$; $C_L = 50 \text{pF}$; $R_L = 500 \Omega$; $T_{amb} = -40 ^{\circ} \text{C}$ to $+85 ^{\circ} \text{C}$.

					LIMIT	s		LIMITS	
SYMBOL	PARAMETER WAVEFORM		Vcc	= 3.3V ±0	.3V	V _{CC} =	: 2.7V	V _{CC} = 1.2V	UNIT
			MIN	TYP ¹	MAX	MIN	MAX	TYP	
t _{PHL}	Propagation delay nAn to nYn; nAn to nYn	1, 4	1.5	2.9	4.4	1.5	5.4	13	ns
t _{PZH} t _{PZL}	3-State output enable time 10E to 1Yn; 40E to 4Yn	3, 4	1.5	4.4	5.8	1.5	6.8	17	ns
t _{PHZ} t _{PLZ}	3-State output disable time 1OE to 1Yn; 4OE to 4Yn	3, 4	1.5	4.3	5.8	1.5	6.8	11	ns
t _{PZH} t _{PZL}	3-State output enable time 2OE to 2Yn; 3OE to 3Yn	2, 4	1.5	4.4	5.5	1.5	6.5	19	ns
t _{PHZ} t _{PLZ}	3-State output disable time 2OE to 2Yn; 3OE to 3Yn	2, 4	1.5	4.9	5.4	1.5	6.4	12	ns

NOTE:

1997 Jul 29 5

^{1.} All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

^{1.} All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

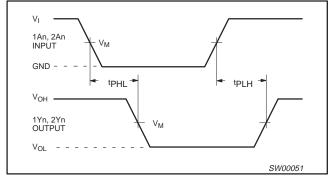
16-bit buffer/line driver (3-State)

74LVC16241A

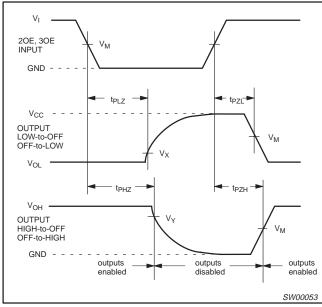
AC WAVEFORMS

 V_M = 1.5V at $V_{CC} \ge 2.7V$; V_M = 0.5 V_{CC} at $V_{CC} < 2.7V$. V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

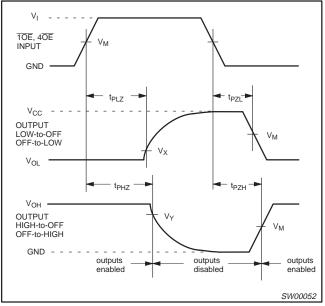
 $V_{\rm X} = V_{\rm OL} + 0.3 {\rm V}$ at $V_{\rm CC} \ge 2.7 {\rm V}$; $V_{\rm X} = V_{\rm OL} + 0.1 {\rm V}_{\rm CC}$ at $V_{\rm CC} < 2.7 {\rm V}$ $V_{\rm Y} = V_{\rm OH} - 0.3 {\rm V}$ at $V_{\rm CC} \ge 2.7 {\rm V}$; $V_{\rm Y} = V_{\rm OH} - 0.1 {\rm V}_{\rm CC}$ at $V_{\rm CC} < 2.7 {\rm V}$



Waveform 1. Input (nAn) to output (nYn) propagation times

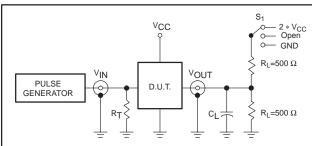


Waveform 2. 3-State enable and disable times for the input (20E, 30E)



Waveform 3. 3-State enable and disable times for the input (1 \overline{OE} , 4 \overline{OE})

TEST CIRCUIT



Test Circuit for 3-State Outputs

SWITCH POSITION

TEST	SWITCH
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	2 * V _{CC}
t _{PHZ} /t _{PZH}	GND

V _{CC}	V _{IN}
< 2.7V 2.7 – 3.6V	V _{CC} 2.7V

DEFINITIONS

R_L = Load resistor

C_L = Load capacitance includes jig and probe capacitance

 $R_T = \mbox{Termination} \ \mbox{resistance} \ \mbox{should} \ \mbox{be} \ \mbox{equal to} \ \mbox{Z_{OUT}} \ \mbox{of pulse} \ \mbox{generators}.$

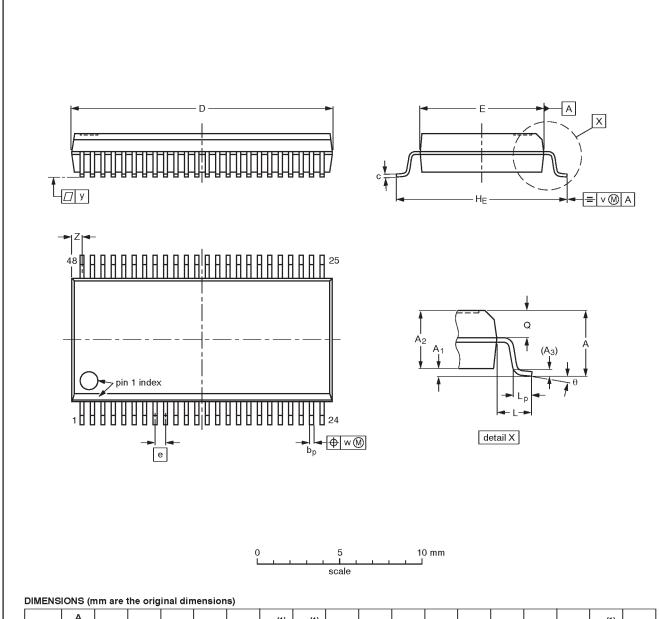
Waveform 4. Load circuitry for switching times

16-bit buffer/line driver (3-State)

74LVC16241A

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



UNIT	A max.	Α1	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

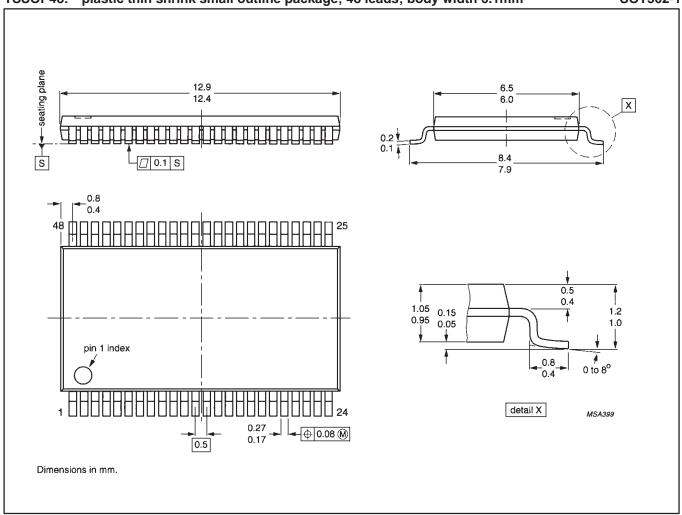
OUTLINE VERSION		REFER	EUROPEAN	ISSUE DATE		
	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT370-1		MO-118AA				93-11-02 95-02-04

1997 Jul 29 7

16-bit buffer/line driver (3-State)

74LVC16241A

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm SOT362-1



16-bit buffer/line driver (3-State)

74LVC16241A

NOTES

16-bit buffer/line driver (3-State)

74LVC16241A

DEFINITIONS							
Data Sheet Identification Product Status		Definition					
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.					
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.					
Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.					

Philips Semiconductors and Philips Electronics North America Corporation reserve the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified. Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

LIFE SUPPORT APPLICATIONS

Philips Semiconductors and Philips Electronics North America Corporation Products are not designed for use in life support appliances, devices, or systems where malfunction of a Philips Semiconductors and Philips Electronics North America Corporation Product can reasonably be expected to result in a personal injury. Philips Semiconductors and Philips Electronics North America Corporation customers using or selling Philips Semiconductors and Philips Electronics North America Corporation Products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors and Philips Electronics North America Corporation for any damages resulting from such improper use or sale.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 1997 All rights reserved. Printed in U.S.A.

print code Date of release: 05-96

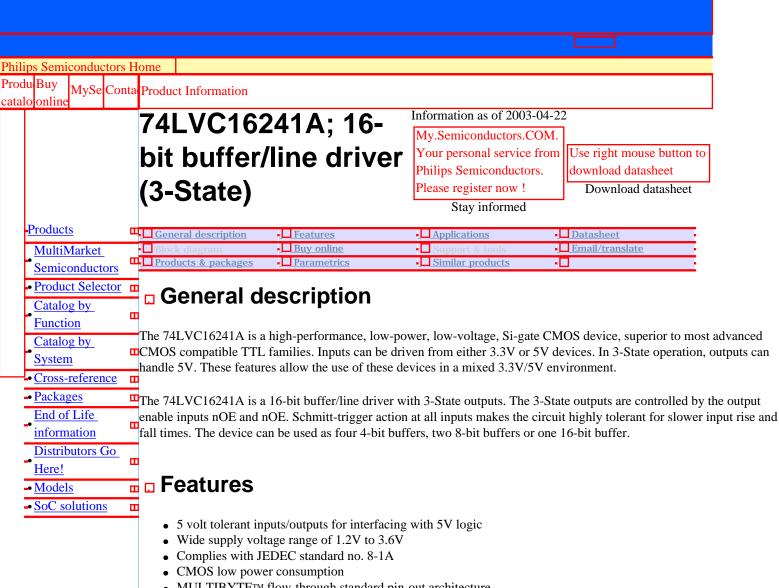
Document order number: 9397-750-04527

Let's make things better.

Philips Semiconductors







- MULTIBYTETM flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels

Applications

AN240: Interfacing 3 Volt and 5 Volt Applications

□ Datasheet

Type number	<u>Title</u>	Publication release date	Datasheet status	Page count	File size (kB)	Datasheet
74LVC16241A	16-bit buffer/line driver (3-State)	7/29/1997	Product specification	10	88	<u>Download</u>

Parametrics

Type number	Package	Description	Propagation Delay(ns)	Voltage	of	Power Dissipation Considerations	Logic Switching Levels	Output Drive Capability
74LVC16241ADGG	SOT362-1 (TSSOP48)	3.3V 16-Bit Buffer/Line Driver; Non- Inverting (3- State)	4~6	Low	48	Low Power or Battery Applications	TTL	Medium
74LVC16241ADL	SOT370-1 (SSOP48)	3.3V 16-Bit Buffer/Line Driver; Non- Inverting (3- State)	4~6	Low	48	Low Power or Battery Applications	TTL	Medium

Products, packages, availability and ordering

Type number	North American type number	Ordering code (12NC)	Marking/Packing IC packing info	<u>Package</u>	Device status	Buy online
74LVC16241ADGG	74LVC16241ADG	9352 351 30112	Standard Marking * Tube	SOT362-1 (TSSOP48)	Full production	order this -
	74LVC16241ADG- T	9352 351 30118	Standard Marking * Reel Pack, SMD, 13"		Full production	order this -
74LVC16241ADL	74LVC16241ADL	9352 351 20112	Standard Marking * Tube	SOT370-1 (SSOP48)	Full production	order this -
	74LVC16241ADL- T	9352 351 20118	Standard Marking * Reel Pack, SMD, 13"	SOT370-1 (SSOP48)	Full production	order this -

□ Similar products

74LVC16241A links to the similar products page containing an overview of products that are similar in function or related to the type number(s) as listed on this page. The similar products page includes products from the same catalog tree(s), relevant selection guides and products from the same functional category.

Email/translate this product information

- Email this product information.
- Translate this product information page from English to:

The English language is the official language used at the semiconductors.philips.com website and webpages. All translations on this website are created through the use of <u>Google Language Tools</u> and are provided for convenience purposes only. No rights can be derived from any translation on this website.

About this Web Site

| Copyright © 2003 Koninklijke Philips N.V. All rights reserved. | Privacy Policy |

| Koninklijke Philips N.V. | Access to and use of this Web Site is subject to the following Terms of Use. |